

T-51-10-08

# ADC0819 8-Bit Serial I/O A/D Converter with 19-Channel Multiplexer

## **General Description**

The ADC0819 is an 8-Bit successive approximation A/D converter with simultaneous serial I/O. The serial input controls an analog multiplexer which selects from 19 input channels or an internal half scale test voltage.

An input sample-and-hold is implemented by a capacitive reference ladder and sampled data comparator. This allows the input signal to vary during the conversion cycle.

Separate serial I/O and conversion clock inputs are provided to facilitate the interface to various microprocessors.

#### **Features**

- Separate asynchronous converter clock and serial data
- 19-Channel multiplexer with 5-Bit serial address logic.
- Built-in sample and hold function.

- Ratiometric or absolute voltage referencing.
- No zero or full-scale adjust required.
- Internally addressable test voltage.
- 0V to 5V input range with single 5V power supply.
- TTL/MOS input/output compatible.
- 28-pin molded chip carrier or 28-pin molded DIP

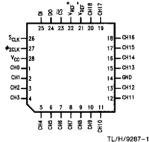
## **Key Specifications**

- 8-Bits ■ Resolution
- ± 1/2LSB and ± 1LSB Total unadjusted error
- Single supply 5V<sub>DC</sub>
- 15 mW ■ Low Power
- Conversion Time 16 us

## **Connection Diagrams**

## **Functional Diagram**

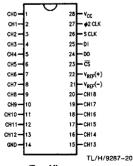
## Molded Chip Carrier (PCC) Package



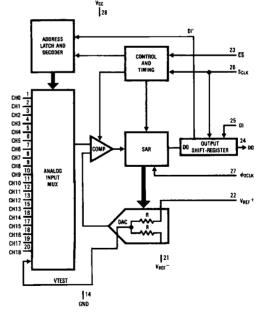
**Top View** 

Order Number ADC0819BCV, CCV See NS Package Number V28A

#### **Dual-In-Line Package**



Top View Order Number ADC0819BCN, CCN, BIN, CIN See NS Package Number N28B



TL/H/9287-2

■NZC5

## Absolute Maximum Ratings (Notes 1 & 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V<sub>CC</sub>) Voltage  $-0.3\mbox{V}$  to  $\mbox{V}_{\mbox{CC}} + 0.3\mbox{V}$ Inputs and Outputs Input Current Per Pin (Note 3)  $\pm 5 mA$ Total Package Input Current (Note 3) ± 20mA Storage Temperature -65°C to +150°C

Package Dissipation at TA = 25°C 875 mW Lead Temperature (Soldering, 10 sec.) Dual-In-Line Package (Plastic) 260°C Surface Mount Package Vapor Phase (60 sec.) 215°C Infrared (15 sec.) 220°C ESD Susceptibility (Note 11) 2000V

## Operating Ratings (Notes 1 & 2)

Supply Voltage (VCC) 4.5 V<sub>DC</sub> to 6.0 V<sub>DC</sub> Temperature Range  $T_{MIN} \le T_A \le T_{MAX}$ ADC0819BCV, ADC0819CCV  $-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le +85^{\circ}\text{C}$ ADC0819BCN, ADC0819CCN  $0^{\circ}C \leq T_A \leq +70^{\circ}C$ ADC0819BIN, ADC0819CIN  $-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le +85^{\circ}\text{C}$ 

## **Electrical Characteristics**

The following specifications apply for  $V_{CC}=5V, V_{REF}=5V, \phi_{2\,CLK}=2.097$  MHz unless otherwise specified. **Boldface limits** apply from  $T_{MIN}$  to  $T_{MAX}$ ; all other limits  $T_A = T_{.I} = 25^{\circ}C$ .

Parameter	Conditions	Typical (Note 6)	Tested Limit (Note 7)	Design Limit (Note 8)	Units
ONVERTER AND MULTIPLEXER	CHARACTERISTICS				
Maximum Total Unadjusted Error ADC0819BCV, BCN, BIN ADC0819CCV, CCN, CIN	V <sub>REF</sub> = 5.00 V <sub>DC</sub> (Note 4)		± ½ ± 1	± ½ ± 1	LSB LSB
Minimum Reference Input Resistance		8		5	kΩ
Maximum Reference Input Resistance		8	11	11	kΩ
Maximum Analog Input Range	(Note 5)		V <sub>CC</sub> + 0.05	V <sub>CC</sub> +0.05	٧
Minimum Analog Input Range			GND-0.05	GND-0.05	V
On Channel Leakage Current	(Note 9) On Channel = 5V Off Channel = 0V		400	1000	пA
	On Channel = 0V Off Channel = 5V (Note 9)		-400	- 1000	nA
Off Channel Leakage Current	(Note 9) On Channel = 5V Off Channel = 0V		-400	- 1000	nA
	On Channel = 0V Off Channel = 5V (Note 9)		400	1000	пА
Minimum V <sub>TEST</sub> Internal Test Voltage	V <sub>REF</sub> = V <sub>CC</sub> , CH 19 Selected		125	125	(Note 10) Counts
Maximum V <sub>TEST</sub> Internal Test Voltage	V <sub>REF</sub> =V <sub>CC</sub> , CH 19 Selected		130	130	(Note 10) Counts
IGITAL AND DC CHARACTERIST	ics				
V <sub>IN(1)</sub> , Logical "1" Input Voltage (Min)	V <sub>CC</sub> =5.25V		2.0	2.0	٧
V <sub>IN(0)</sub> , Logical ''0'' Input Voltage (Max)	V <sub>CC</sub> =4.75V		0.8	0.8	٧
l <sub>IN(1)</sub> , Logical "1" Input Current (Max)	V <sub>IN</sub> = 5.0V	0.005	2.5	2.5	μΑ
I <sub>IN(0)</sub> , Logical "0" Input Current (Max)	V <sub>IN</sub> =0V	-0.005	-2.5	- 2.5	μΑ

## **Electrical Characteristics (Continued)**

The following specifications apply for  $V_{CC}=5V$ ,  $V_{REF}=5V$ ,  $\phi_{2\,CLK}=2.097$  MHz unless otherwise specified. **Boldface limits** apply from  $T_{MIN}$  to  $T_{MAX}$ ; all other limits  $T_A=T_J=25^{\circ}C$ .

Parameter	Conditions	Typical (Note 6)	Tested Limit (Note 7)	Design Limit (Note 8)	Units
DIGITAL AND DC CHARACTERIST	ICS (Continued)				
V <sub>OUT(1)</sub> , Logical "1" Output Voltage (Min)	V <sub>CC</sub> = 4.75V I <sub>OUT</sub> = -360 μA I <sub>OUT</sub> = -10 μA		2.4 4.5	2.4 4.5	V
V <sub>OUT(0)</sub> , Logical "0" Output Voltage (Max)	V <sub>CC</sub> = 5.25V I <sub>OUT</sub> = 1.6 mA		0.4	0.4	٧
I <sub>OUT</sub> , TRI-STATE Output Current (Max)	V <sub>OUT</sub> =0V V <sub>OUT</sub> =5V	-0.01 0.01	-3 3	-3 3	μA μA
I <sub>SOURCE</sub> , Output Source Current (Min)	V <sub>OUT</sub> =0V	-14	-6.5	-6.5	mA
ISINK, Output Sink Current (Min)	V <sub>OUT</sub> =V <sub>CC</sub>	16	8.0	8.0	mA
I <sub>CC</sub> , Supply Current (Max)	CS = 1, V <sub>REF</sub> Open	1	2.5	2.5	mA
I <sub>REF</sub> (Max)	V <sub>RFF</sub> =5V	0.7	1	1	mA

#### AC CHARACTERISTICS

Parameter		Conditions	Typical (Note 6)	Tested Limit (Note 7)	Design Limit (Note 8)	Units
φ <sub>2 CLK</sub> , φ <sub>2</sub> Clock Frequency	MIN		0.70		1.0	MHz
	MAX		4.0	2.0	2.1	
S <sub>CLK</sub> , Serial Data Clock	MIN				5.0	KHz
Frequency	MAX		1000	525	525	
T <sub>C</sub> , Conversion Process Time	MIN	Not Including MUX Addressing and	26		26	φ <sub>2</sub> cycles
	мах	Analog Input Sampling Times	32		32	
t <sub>ACC</sub> , Access Time Delay From CS	MIN				1	φ <sub>2</sub> cycles
Falling Edge to DO Data Valid	MAX				3	
t <sub>SET-UP</sub> , Minimum Set-up Time of $\overline{\text{CS}}$ Falling Edge to S <sub>CLK</sub> Rising Edge					4/\$2CLK+\frac{1}{2 \text{SCLK}}	sec
t <sub>HCS</sub> , CS Hold Time After the Falling Edge of S <sub>CLK</sub>					0	ns
t CS, Total CS Low Time	MIN				t <sub>set-up</sub> +8/S <sub>CLK</sub>	sec
	MAX				t <del>cs</del> (min)+26/φ <sub>2CLK</sub>	sec
t <sub>HDI</sub> , Minimum DI Hold Time from S <sub>CLK</sub> Rising Edge			0		0	ns
t <sub>HDO</sub> , Minimum DO Hold Time from S <sub>CLK</sub> Falling Edge		$R_L = 30k$ , $C_L = 100 pF$			10	ns
t <sub>SDI</sub> , Minimum DI Set-up Time to S <sub>CLK</sub> Rising Edge			200		400	ns
t <sub>DDO</sub> , Maximum Delay From S <sub>CLK</sub> Falling Edge to DO Data Valid		$R_L = 30k$ , $C_L = 100 pF$	180	200	250	ns
t <sub>TRI</sub> , Maximum DO Hold Time, (CS Rising edge to DO TRI-STATE)		R <sub>L</sub> = 3k, C <sub>L</sub> = 100 pF	90	150	150	ns

**Electrical Characteristics** The following specifications apply for  $V_{CC} = 5V$ ,  $t_r = t_f = 20$  ns,  $V_{REF} = 5V$ , unless otherwise specified. Boldface limits apply from Twin to Tway: all other limits Ta = T1 = 25°C.

Parameter		Conditions	Typical (Note 6)	Tested Limit (Note 7)	Design Limit (Note 8)	Units
AC CHARACTERISTIC	S (Continued)					
t <sub>CA</sub> , Analog Sampling Time	After Address is Latched  CS = Low			,	3/S <sub>CLK</sub> + 1 μs	sec
t <sub>RDO</sub> , Maximum DO	R <sub>L</sub> =30 kΩ,	"TRI-STATE" to "HIGH" State	75	150	150	ns
Rise Time	C <sub>L</sub> = 100 pf	"LOW" to "HIGH" State	150	300	300	113
t <sub>FDO</sub> , Maximum DO	$R_L = 30 k\Omega$ ,	"TRI-STATE" to "LOW" State	75	150	150	ns
Fall Time	C <sub>L</sub> = 100 pf	"HIGH" to "LOW" State	150	300	300	115
C <sub>IN</sub> , Maximum Input	Analog Inputs	, ANO-AN10 and V <sub>REF</sub>	11		55	ρF
Capacitance	All Others		5		15	, pr

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not apply when operating the device beyond its specified operating conditions.

Note 2: All voltages are measured with respect to ground.

Note 3: Under over voltage conditions ( $V_{IN}$ <0V and  $V_{IN}$ > $V_{CC}$ ) the maximum input current at any one pin is  $\pm 5$  mA. If the voltage at more than one pin exceeds V<sub>CC</sub> + .3V the total package current must be limited to 20 mA. For example the maximum number of pins that can be over driven at the maximum current level of

Note 4: Total unadjusted error includes offset, full-scale, linearity, multiplexer, and hold step errors.

Note 5: Two on-chip diodes are tied to each analog input, which will forward-conduct for analog input voltages one diode drop below ground or one diode drop greater than V<sub>CC</sub> supply. Be careful during testing at low V<sub>CC</sub> levels (4.5V), as high level analog inputs (5V) can cause this input diode to conduct, especially at elevated temperatures, and cause errors for analog inputs near full-scale. The spec allows 50 mV forward bias of either diode. This means that as long as the analog V<sub>IN</sub> does not exceed the supply voltage by more than 50 mV, the output code will be correct. To achieve an absolute 0 V<sub>DC</sub> to 5 V<sub>DC</sub> input voltage range will therefore require a minimum supply voltage of 4.950 V<sub>DC</sub> over temperature variations, initial tolerance and loading.

Note 6: Typicals are at 25°C and represent most likely parametric norm.

Note 7: Tested Limits are guaranteed to National's AOQL (Average Outgoing Quality Level).

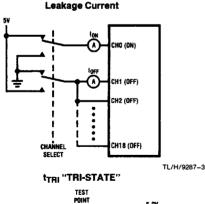
Note 8: Design Limits are guaranteed, but not 100% production tested. These limits are not used to calculate outgoing quality levels.

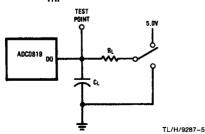
Note 9: Channel leakage current is measured after the channel selection.

Note 10: 1 count = V<sub>REF</sub>/256.

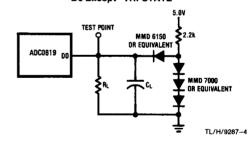
Note 11: Human body model; 100 pF discharged through a 1.5 k $\Omega$  resistor.

### **Test Circuits**



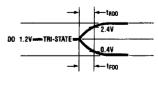


#### D0 Except "TRI-STATE"



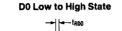
# **Timing Diagrams**

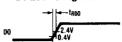
## D0 "TRI-STATE" Rise & Fall Times

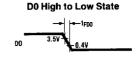


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# Timing Diagrams (Continued)



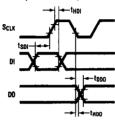




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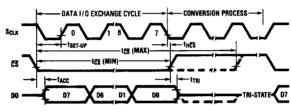
## **Data Input and Output Timing**

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TL/H/9287-9

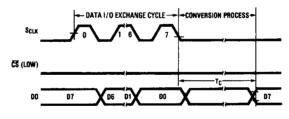
#### Timing with a continuous SCLK



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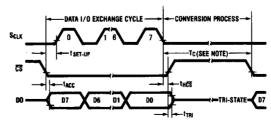
\*Strobing CS High and Low will abort the present conversion and initiate a new serial I/O exchange.

## Timing with a gated $S_{CLK}$ and $\overline{CS}$ Continuously Low



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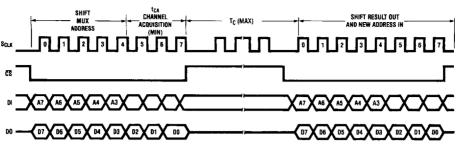
#### Using CS To TRI-STATE D0



TL/H/9287-12

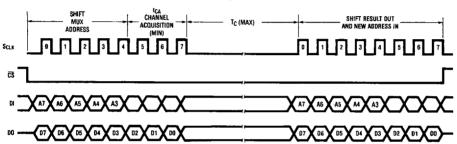
Note: Strobing CS Low during this time interval will abort the conversion in process.

#### **CS** High During Conversion



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## **CS** Low During Conversion



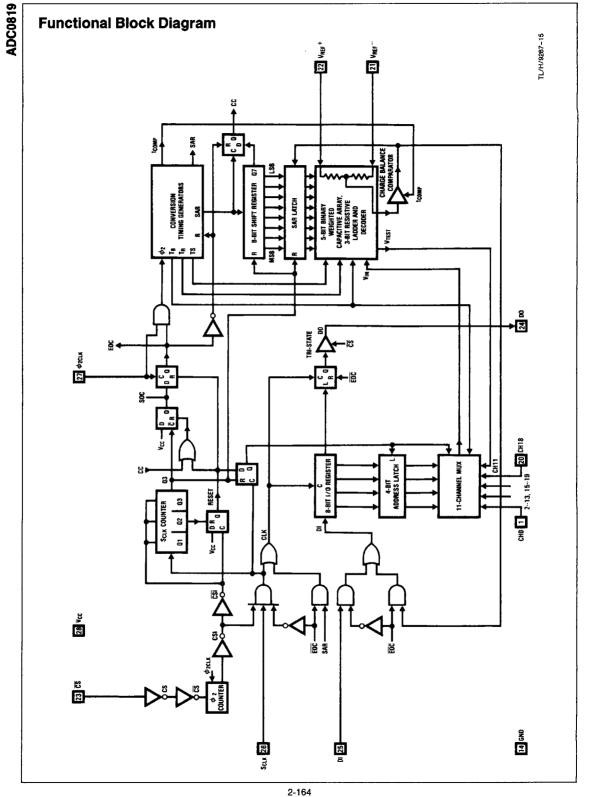
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## **Channel Addressing Table**

**TABLE I. ADC 0819 Channel Addressing** 

		MU	ANALOG CHANNEL					
A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	A <sub>4</sub>	A <sub>3</sub>	A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>	SELECTED
0	0	0	0	0	Х	Х	Х	CH0
0	0	0	0	1	Х	X	Х	CH1
0	0	0	1	0	Х	X	Х	CH2
0	0	0	1	1	Х	Х	Х	CH3
0	0	1	0	0	Х	X	Х	CH4
0	0	1	0	1	Х	X	Х	CH5
0	0	1	1	0	X	X	X	CH6
0	0	1	1	1	Х	X	X	CH7
0	1	0	0	0	Х	X	Х	CH8
0	1	0	0	1	Х	X	X	CH9
0	1	0	1	0	××××	X X X X	X	CH10
0	1	0	1	1	Х	X	Х	CH11
0	1	1	0	0	Х	X	X	CH12
0	1	1	0	1	Х	X	X	CH13
0	1	1	1	0	Х	Х	X	CH14
0	1	1	1	1	X	X	X	CH15
1	0	0	0	0	Х	X	X	CH16
1	0	0	0	1	X X X	X X X	X	CH17
1	0	0	1	0	Х	Х	Х	CH18
1	0	0	1	1	Х	X	Х	V <sub>TEST</sub>
1	0	1	0	0	Х	Х	Х	No Channel Select
1	0	1	0	1	Х	Х	Х	No Channel Select
1	0	1	1	0	Х	Х	X	No Channel Select
1	0	1	1	1	Х	Х	Х	No Channel Select
1	1	Х	Х	Х	Х	Х	Х	Logic Test Mode*

<sup>\*</sup>Analog channel inputs CH0 thru CH4 are logic outputs



## **Functional Description**

#### 1.0 DIGITAL INTERFACE

The ADC0819 uses five input/output pins to implement the serial interface. Taking chip select (CS) low enables the I/O data lines (DO and DI) and the serial clock input (S<sub>CLK</sub>). The result of the last conversion is transmitted by the A/D on the DO line, while simultaneously the DI line receives the address data that selects the mux channel for the next conversion. The mux address is shifted in on the rising edge of SCIK and the conversion data is shifted out on the falling edge. It takes eight S<sub>CLK</sub> cycles to complete the serial I/O. A second clock  $(\phi_2)$  controls the SAR during the conversion process and must be continuously enabled.

#### 1.1 CONTINUOUS SCLK

With a continuous S<sub>CLK</sub> input CS must be used to synchronize the serial data exchange (see Figure 1). The ADC0819 recognizes a valid CS one to three φ<sub>2</sub> clock periods after the actual falling edge of CS. This is implemented to ensure noise immunity of the CS signal. Any spikes on CS less than one  $\phi_2$  clock period will be ignored.  $\overline{\text{CS}}$  must remain low during the complete I/O exchange which takes eight SCLK cycles. Although CS is not immediately acknowledged for the purpose of starting a new conversion, the falling edge of CS immediately enables DO to output the MSB (D7) of the previous conversion.

The first S<sub>CLK</sub> rising edge will be acknowledged after a setup time (t<sub>set-up</sub>) has elapsed from the falling edge of CS. This and the following seven S<sub>CLK</sub> rising edges will shift in the channel address for the analog multiplexer. Since there are 19 channels only five address bits are utilized. The first five S<sub>CLK</sub> cycles clock in the mux address, during the next three S<sub>CLK</sub> cycles the analog input is selected and sampled. During this mux address/sample cycle, data from the last conversion is also clocked out on DO. Since D7 was clocked out on the falling edge of CS only data bits D6-D0 remain to be received. The following seven falling edges of S<sub>CLK</sub> shift out this data on DO

The 8th S<sub>CLK</sub> falling edge initiates the beginning of the A/D's actual conversion process which takes between 26 and 32 φ<sub>2</sub> cycles (T<sub>C</sub>). During this time CS can go high to TRI-STATE DO and disable the SCIK input or it can remain low. If CS is held low a new I/O exchange will not start until the conversion sequence has been completed, however once the conversion ends serial I/O will immediately begin. Since there is an ambiguity in the conversion time (T<sub>C</sub>) synchronizing the data exchange is impossible. Therefore CS should go high before the 26th  $\phi_2$  clock has elasped and return low after the 32nd  $\phi_2$  to synchronize serial communication.

A conversion or I/O operation can be aborted at any time by strobing  $\overline{CS}$ . If  $\overline{CS}$  is high or low less than one  $\phi_2$  clock it will be ignored by the A/D. If the CS is strobed high or low between 1 to 3  $\phi_2$  clocks the A/D may or may not respond. Therefore  $\overline{CS}$  must be strobed high or low greater than 3  $\phi_2$ clocks to ensure recognition. If a conversion or I/O exchange is aborted while in process the consequent data output will be erroneous until a complete conversion sequence has been implemented.

#### 1.2 DISCONTINUOUS SCLK

Another way to accomplish synchronous serial communication is to tie CS low continuously and disable SCLK after its 8th falling edge (see Figure 2). SCLK must remain low for

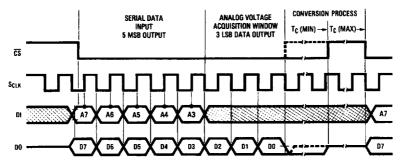


FIGURE 1

TL/H/9287-16

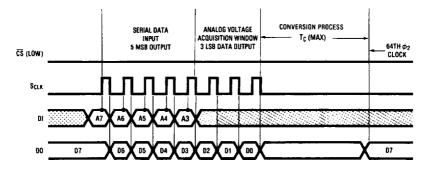


FIGURE 2

TI /H/9287-17

## Functional Description (Continued)

at least 32  $\phi_2$  clocks to ensure that the A/D has completed its conversion. If S<sub>CLK</sub> is enabled sooner, synchronizing to the data output on DO is not possible since an end of conversion signal from the A/D is not available and the actual conversion time is not known. With CS low during the conversion time (32 \$\phi\_2\$ max) DO will go high or low after the eighth falling edge of S<sub>CLK</sub> until the conversion is completed. Once the conversion is through DO will transmit the MSB. The rest of the data will be shifted out once SCLK is enabled as discussed previously.

If CS goes high during the conversion sequence DO is tristated, and the result is not affected so long as CS remains high until the end of the conversion.

#### 1.2 MULTIPLEXER ADDRESSING

The five bit mux address is shifted, MSB first, into DI. Input data corresponds to the channel selected as shown in table Care should be taken not to send an address greater than or equal to twenty four (11XXX) as this puts the A/D in a digital testing mode. In this mode the analog inputs CH0 thru CH4 become digital outputs, for our use in production testing.

#### 2.0 ANALOG INPUT

#### 2.1 THE INPUT SAMPLE AND HOLD

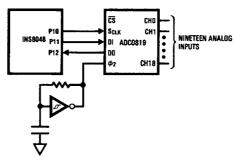
The ADC0819's sample/hold capacitor is implemented in its capacitive ladder structure. After the channel address is received, the ladder is switched to sample the proper analog input. This sampling mode is maintained for 1 µsec after the eighth S<sub>CLK</sub> falling edge. The hold mode is initiated with the start of the conversion process. An acquisition window of  $3t_{\mbox{\scriptsize SCLK}} + 1~\mu\mbox{\scriptsize sec}$  is therefore available to allow the ladder capacitance to settle to the analog input voltage. Any change in the analog voltage before or after the acquisition window will not effect the A/D conversion result.

In the most simple case, the ladder's acquisition time is determined by the Ron (3K) of the multiplexer switches and the total ladder capacitance (90pf). These values yield an acquisition time of about 2 µsec for a full scale reading. Therefore the analog input must be stable for at least 2 µsec before and 1  $\mu sec$  after the eighth  $S_{CLK}$  falling edge to ensure a proper conversion. External input source resistance and capacitance will lengthen the acquisition time and should be accounted for.

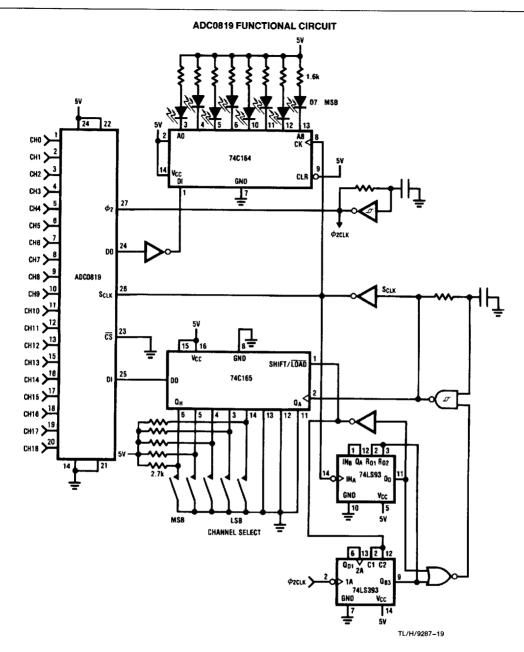
Other conventional sample and hold error specifications are included in the error and timing specs of the A/D. The hold step and gain error sample/hold specs are taken into account in the ADC0819's total unadjusted error, while the hold settling time is included in the A/D's max conversion time of 32  $\phi_2$  clock periods. The hold droop rate can be thought of as being zero since an unlimited amount of time can pass between a conversion and the reading of data. However, once the data is read it is lost and another conversion is started.

## **Typical Applications**

#### **ADC0819-INS8048 INTERFACE**



TL/H/9287-18



# **Ordering Information**

Temperature	Range	0°C to +70°C	-40°C to +85°C			
Total Unadjusted	± 1/2 LSB	ADC0819BCN	ADC0819BCV	ADC0819BIN		
Error	±1LSB	ADC0819CCN	ADC0819CCV	ADC0819CIN		
Package Outline		N28B	V28A	N28B		